



**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**Re Application of:**

Ball et al.

**Serial No.:** 09/854,759

**Filed:** May 14, 2001

**For:** USING BACKGRIND WAFER TAPE  
TO ENABLE WAFER MOUNTING OF  
BUMPED WAFERS

**Examiner:** J. Haran

**Group Art Unit:** 1733

**Attorney Docket No.:** 2269-4589US  
(99-1151.00/US)

**CERTIFICATE OF MAILING**

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**AMENDMENT UNDER 37 C.F.R. § 1.116**

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Sir:

This amendment is in response to the final Office Action of December 9, 2003 whose initial period of response is set to expire on March 9, 2004.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 14 of this paper.

2/15/04